

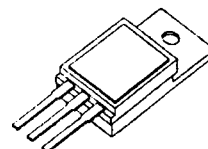


PRELIMINARY

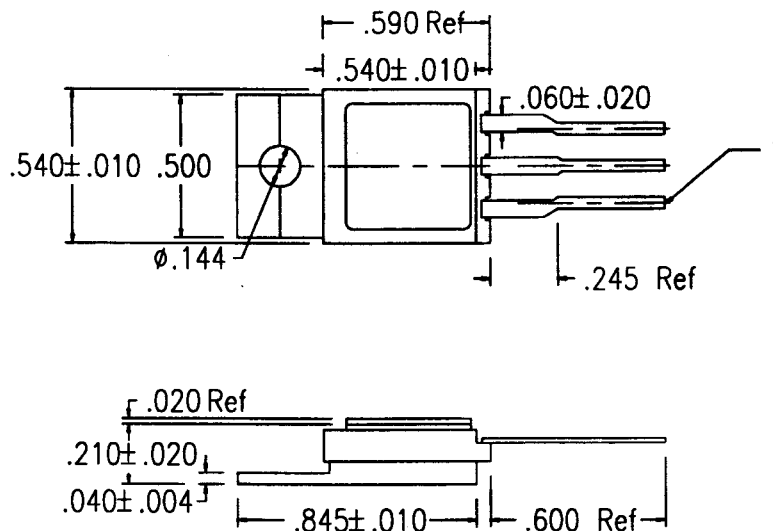
SOLID STATE DEVICES, INC

14849 Firestone Boulevard · La Mirada, CA 90638
Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424**Designer's Data Sheet****FEATURES:**

- Rugged construction with poly silicon gate
- Low RDS(on) and high transconductance
- Excellent high temperature stability
- Very fast switching speed
- Fast recovery and superior dv/dt performance
- Increased reverse energy capability
- Low input and transfer capacitance for easy paralleling
- Hermetically sealed power package
- Low inductance, ceramic package
- Flat leads for high frequency applications
- TX, TXV and Space Level screening available
- Replaces: IRF054 Types

SFF054C
35 AMP
60 VOLTS
0.025Ω
N-CHANNEL
POWER MOSFET
TO-254C**MAXIMUM RATINGS**

CHARACTERISTIC	SYMBOL	VALUE	UNIT
Drain to Source Voltage	V _{DS}	60	Volts
Gate to Source Voltage	V _{GS}	±20	Volts
Continuous Drain Current	I _D	35	Amps
Operating and Storage Temperature	T _{OP} & T _{STG}	-55 to +150	°C
Thermal Resistance, Junction to Case	R _{θJC}	0.83	°C/W
Total Device Dissipation @ TC=25°C	P _D	150	Watts
Total Device Dissipation @ TC=55°C		114	

PACKAGE OUTLINE: CERAMIC TO-254**PIN OUT:**
PIN 1: DRAIN
PIN 2: SOURCE
PIN 3: GATE


NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: F00063 B**MED**

SFF054C

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ELECTRICAL CHARACTERISTICS @ T_J=25 °C (Unless Otherwise Specified)

RATING		SYMBOL	MIN	TYP	MAX	UNIT
Drain to Source Breakdown Voltage (V _{GS} =0 V, I _D =1mA)		BV_{DSS}	60	---	---	V
Drain to Source on State Resistance (V _{GS} =10 V, I _D =60% Rated I _D)		R_{DS(on)}	---	0.020	0.025	Ω
On State Drain Current (V _{DS} > I _{D(on)} X R _{DS(on)} Max, V _{GS} =10 V)		I_{D(on)}	35	---	---	A
Gate Threshold Voltage (V _{DS} =V _{GS} , I _D =250μA)		V_{GS(th)}	2.0	2.6	4.0	V
Forward Transconductance (V _{DS} > I _{D(on)} X R _{DS(on)} Max, I _{DS} =35A)		g_{fs}	20	45	---	S(Ω)
Zero Gate Voltage Drain Current (V _{DS} =80%max rated voltage, V _{GS} =0 V) (V _{DS} =80% rated V _{DS} , V _{GS} =0 V, T _A =125°C)		I_{DSS}	---	---	25 250	μA
Gate to Source Leakage Forward Gate to Source Leakage Reverse	At rated V _{GS}	I_{GSS}	---	---	100 -100	nA
Total Gate Charge Gate to Source Charge Gate to Drain Charge	V _{GS} =10 Volts 80% rated V _{DS} Rated I _D	Q_g Q_{gs} Q_{gd}	80 10 34	---	180 45 77	nC
Turn on Delay Time Rise Time Turn Off Delay Time Fall Time	V _{DD} =50% rated V _{DS} I _D =35A R _G ≤6.2Ω	t_{d(on)} t_r t_{d(off)} t_f	---	30 20 60 30	33 180 100 100	nsec
Diode Forward Voltage (I _S =rated I _D , V _{GS} =0 V, T _J =25°C)		V_{SD}	---	1.1	2.5	V
Diode Reverse Recovery Time Reverse Recovery Charge	T _J =25°C I _F =10A di/dt=100 A/ sec	t_{rr} Q_{RR}	---	---	280 2.2	nsec μC
Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{GS} =0 Volts V _{DS} =25 Volts f= 1 MHz	C_{iss} C_{oss} C_{rss}	---	4600 2000 340	---	pF

For thermal derating curves and other characteristic curves please contact SSDI Marketing Department.